- =

Į.

ľŲ

1. A semiconductor device comprising:

an insulating film comprising silicon oxide on an insulating surface, wherein the insulating film includes halogen at a concentration of  $5x10^{20}$  cm<sup>-3</sup> or less and carbon at a concentration of  $5x10^{19}$  cm<sup>-3</sup> or less which are detected by second ion mass spectroscopy.

- 2. A device according to claim 1, wherein the halogen is chlorine.
- 3. A device according to claim 1, wherein the halogen is fluorine.
- 4. A device according to claim 1, wherein the insulating film includes carbon at a concentration of 1x10<sup>18</sup> cm<sup>-3</sup> or less which is detected by the second ion mass spectroscopy.
- 5. A device according to claim 1,
  wherein the insulating film includes halogen at a concentration of 1 x 10<sup>17</sup> cm<sup>-3</sup> or more which is detected by the second ion mass spectroscopy.
  - 6. A device according to claim 1, wherein the insulating film is a gate insulating film.
  - 7. A device according to claim 1, wherein the insulating film is an insulating film in a thin film transistor.
  - 8. A device according to claim 1, wherein the insulating film covers an even surface over a glass substrate.
  - 9. A device according to claim 1,
    wherein the insulating film is formed by plasma chemical vapor deposition using an organic silane.
  - 10. A device according to claim 9, wherein the organic silane comprises at least a material selected from the group consisting of Si(OC<sub>2</sub>H<sub>5</sub>)<sub>4</sub>, Si<sub>2</sub>O(OC<sub>2</sub>H<sub>5</sub>)<sub>6</sub>, Si<sub>3</sub>O<sub>2</sub>(OC<sub>2</sub>H<sub>5</sub>)<sub>8</sub>, Si<sub>4</sub>O<sub>3</sub>(OC<sub>2</sub>H<sub>5</sub>)<sub>10</sub> and Si<sub>5</sub>O<sub>4</sub>(OC<sub>2</sub>H<sub>5</sub>)<sub>12</sub>.



- 12. A device according to claim 11, wherein the concentrations of halogen and carbon are detected by secondary ion mass spectroscopy.
- 13. A device according to claim 11, wherein the halogen is chlorine.

nnaun'

ΙΠ

more.

- 14. A device according to claim 11, wherein the halogen is fluorine.
- 15. A device according to claim 11, wherein the insulating film includes carbon at a concentration of 1x10<sup>18</sup> cm<sup>-3</sup> or less.
- 16. A device according to claim 11, wherein the insulating film includes halogen at a concentration of  $1 \times 10^{17}$  cm<sup>-3</sup> or
- 17. A device according to claim 11,

  wherein the insulating film is formed by plasma chemical vapor deposition using an organic silane.
  - 18. A device according to claim 17, wherein the organic silane comprises at least a material selected from the group consisting of  $Si(OC_2H_5)_4$ ,  $Si_2O(OC_2H_5)_6$ ,  $Si_3O_2(OC_2H_5)_8$ ,  $Si_4O_3(OC_2H_5)_{10}$  and  $Si_5O_4(OC_2H_5)_{12}$ .
  - 19. A semiconductor device including at least a thin film transistor comprising:
    a crystalline semiconductor island on an insulating surface;
    a silicon oxide film over the crystalline semiconductor island; and
    a conductive film including at least one of aluminum, titanium, and titanium nitride,
    said conductive film being formed on the silicon oxide film,
    wherein the silicon oxide film includes halogen at a concentration of  $5x10^{20}$  cm<sup>-3</sup> or less and carbon at a concentration of  $5x10^{19}$  cm<sup>-3</sup> or less.

20. A device accomplete concentrations of halogen and carbon are detected by secondary ion mass spectroscopy.

- 21. A device according to claim 19, wherein the halogen is chlorine.
- 22. A device according to claim 19, wherein the halogen is fluorine.

-

JŪ LŲ

13

- 23. A device according to claim 19, wherein the silicon oxide film includes carbon at a concentration of 1x10<sup>18</sup> cm<sup>-3</sup> or less.
- 24. A device according to claim 19, wherein the silicon oxide film includes halogen at a concentration of 1 x 10<sup>17</sup> cm<sup>-3</sup> or more.
- 25. A device according to claim 19,
  wherein the silicon oxide film is formed by plasma chemical vapor deposition using an organic silane.
- 26. A device according to claim 17, wherein the organic silane comprises at least a material selected from the group Consisting of Si(OC<sub>2</sub>H<sub>5</sub>)<sub>4</sub>, Si<sub>2</sub>O(OC<sub>2</sub>H<sub>5</sub>)<sub>6</sub>, Si<sub>3</sub>O<sub>2</sub>(OC<sub>2</sub>H<sub>5</sub>)<sub>8</sub>, Si<sub>4</sub>O<sub>3</sub>(OC<sub>2</sub>H<sub>5</sub>)<sub>10</sub> and Si<sub>5</sub>O<sub>4</sub>(OC<sub>2</sub>H<sub>5</sub>)<sub>12</sub>.
- 27. A semiconductor device including at least a thin film transistor comprising:
  a crystalline semiconductor island on an insulating surface;
  a gate insulating film including silicon oxide on the crystalline semiconductor island;
  and

a gate electrode on the gate insulating film, wherein the gate insulating film includes halogen at a concentration of  $5x10^{20}$  cm<sup>-3</sup> or less and carbon at a concentration of  $5x10^{19}$  cm<sup>-3</sup> or less.

28. A device according to claim 27, wherein the concentrations of halogen and carbon are detected by secondary ion mass spectroscopy.

- 29. A device according to claim 27, wherein the halogen is chlorine.
- 30. A device according to claim 27, wherein the halogen is fluorine.

- 31. A device according to claim 27, wherein the gate insulating film includes carbon at a concentration of 1x10<sup>18</sup> cm<sup>-3</sup> or less.
- 32. A device according to claim 27, wherein the gate insulating film includes halogen at a concentration of 1 x  $10^{17}$  cm<sup>-3</sup> or more.
- 33. A device according to claim 27, wherein the gate insulating film is formed by plasma chemical vapor deposition using an organic silane.
- 34. A device according to claim 33, wherein the organic silane comprises at least a material selected from the group consisting of Si(OC<sub>2</sub>H<sub>5</sub>)<sub>4</sub>, Si<sub>2</sub>O(OC<sub>2</sub>H<sub>5</sub>)<sub>6</sub>, Si<sub>3</sub>O<sub>2</sub>(OC<sub>2</sub>H<sub>5</sub>)<sub>8</sub>, Si<sub>4</sub>O<sub>3</sub>(OC<sub>2</sub>H<sub>5</sub>)<sub>10</sub> and Si<sub>5</sub>O<sub>4</sub>(OC<sub>2</sub>H<sub>5</sub>)<sub>12</sub>.

-

THULLER